

Applicants have amended the above-identified application to change the Attorney Docket Number from 50001.31US01/SFI 551 to 35013.5100 for easier identification of the application by Applicants.

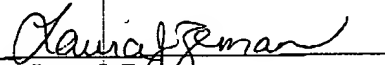
In addition, Applicants have amended the wording of the last line of claim 7 of the application, and attach hereto a marked-up version showing the change made to claim 7 by this Amendment. The attached page is captioned "VERSION WITH MARKINGS TO SHOW CHANGES MADE".

Should the Examiner wish to discuss any of the above in greater detail, then the Examiner is invited to telephone the undersigned at the Examiner's convenience.

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Respectfully submitted,

By



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VERSION WITH MARKINGS TO SHOW CHANGES MADE

Claim 7 has been amended as follows:

7. (AMENDED) An improvement in an apparatus for orbital polishing of semiconductor wafers to planarize surface of the wafers, the apparatus comprising a pad mounted in a platen, the platen attached to mechanical means for causing the pad to orbit about an axis offset from a central axis of the pad, the pad spaced from carrier to wafer, the carrier coupled to a drive motor to rotate the carrier, and means for pressing a wafer in the carrier forcibly against the pad, the improvement comprising: offsetting the orbital axis from the central axis of the pad by from about 0.05 to about 2.0 mm to cause vibratory motion when the [drive motor rotates the carrier] pad orbits.